

Through Hole Lamp Product Data Sheet LTL30EKDFGJ

Spec No.: DS20-2007-0123 Effective Date: 07/30/2009 Revision: A



BNS-OD-FC001/A4

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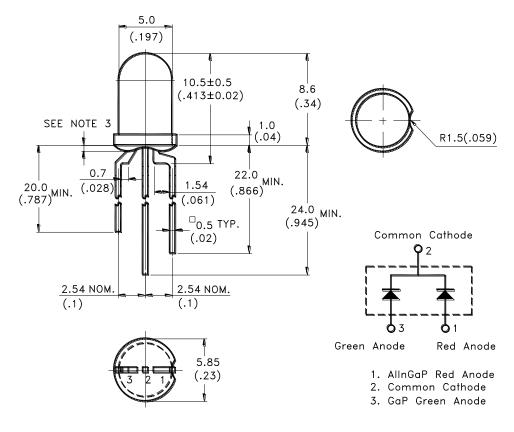


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Features

- * AllnGaP Red and Gap Green chips are matched for uniform light output.
- * T-1 3/4 type package.
- * Long life-solid state reliability.
- * Low power consumption.
- * Pb Free and RoHS compliant

Package Dimensions



Part No.	Lens	Source Color
LTL30EKDFGJ	White Diffused	AllnGaP Red / GaP Green

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specification is subject to change without notice.

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Parameter	AllnGaP Red	GaP Green	Unit
Power Dissipation	75	120	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	90	90	mA
Continuous Forward Current	30	30	mA
Derating Linear From 50°C	0.4	0.4	mA/°C
Reverse Voltage	5	5	V
Operating Temperature Range	-55°C to + 100°C		
Storage Temperature Range	-55°C to + 100°C		
Lead Soldering Temperature [2.0 mm(.078") From Body]	260°C for 5 Seconds		

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Parameter	Symbol	Color	Min.	Тур.	Max.	Unit	Test Condition
		Red	110	180	310		$I_F = 20 mA$
Luminous Intensity	Iv	Green	30	50	85	mcd	$I_F = 20mA$ $I_F = 20mA$
Duminous intensity	ĨV	Green	50	50	05	incu	Note $1,4$
X7:	20	Red		30		1	
Viewing Angle	20 _{1/2}	Green		30		deg	Note 2 (Fig.6)
Peak Emission	λρ	Red		650		nm	Measurement
I Cak Emission	λр	Green		565			@Peak (Fig.1)
Dominant Wavelength	λd	Red	634	639	644	nm	Note 3
Dominant wavelength	λά	Green	563	569	580	11111	
Spectral Line Half-Width	Δλ	Red		20		nm	
Speetral Ellie Hall- width		Green		30		11111	
Forward Voltage	V_{F}	Red		2.0	2.4	v	IF = 20mA
Polward Voltage	V F	Green		2.1	2.6	v	
Reverse Current	IR	Red			100	μA	
	IK	Green			100	μΑ	$V_R = 5V$
Capacitance	С	Red		80		pF	
Capacitalice	C	Green		35		pF	$V_F = 0$, $f = 1MHz$

Note: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission International De L'Eclairage) eye-response curve.

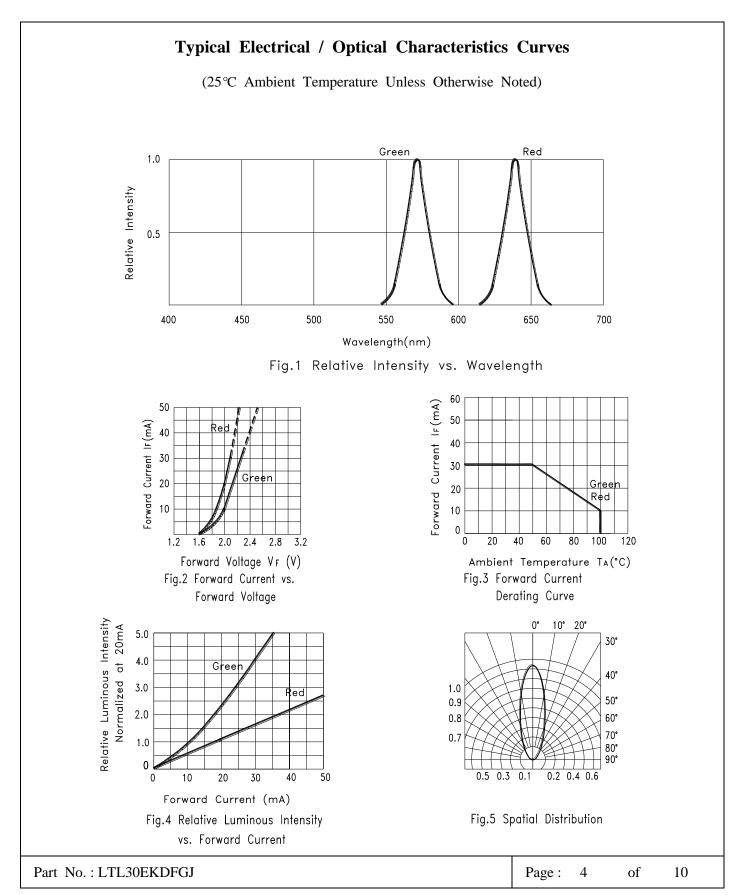
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λ_d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. The Iv guarantee should be added $\pm 15\%$.

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Bin Table Specifications

Luminous Intensi	ity AllnGaP Red	Unit : mcd @20mA
Bin Code	Min.	Max.
F	110	140
G	140	180
Н	180	240
J	240	310

Luminous Inten	sity GaP Green Un	it : mcd @20mA
Bin Code	Min.	Max.
А	30	38
В	38	50
С	50	65
D	65	85

Note: Tolerance of each bin limit is $\pm 15\%$

Bin Code : X-X (Luminous Intensity RED– Luminous Intensity GREEN)

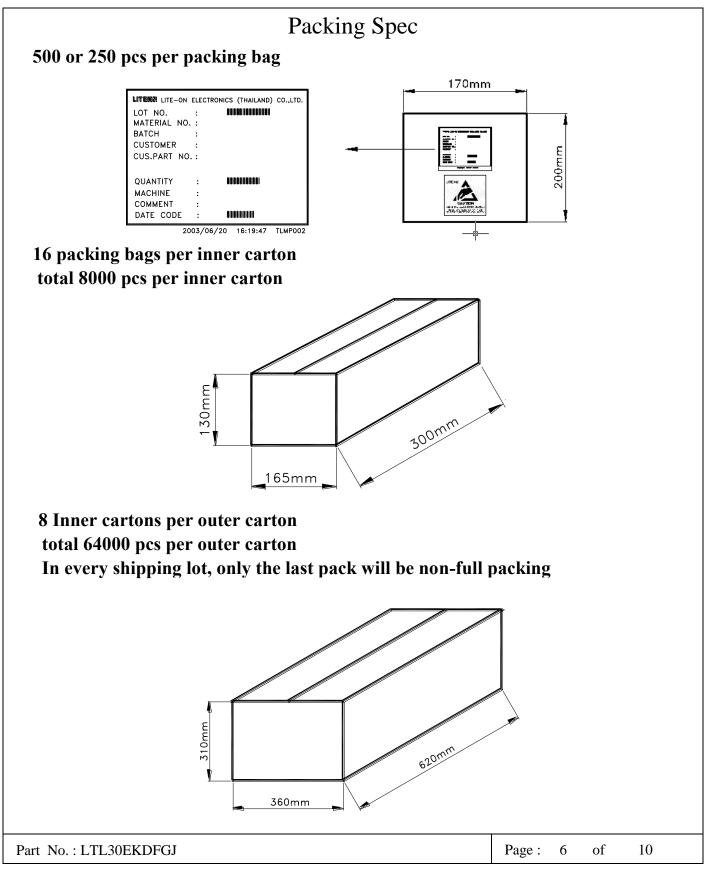
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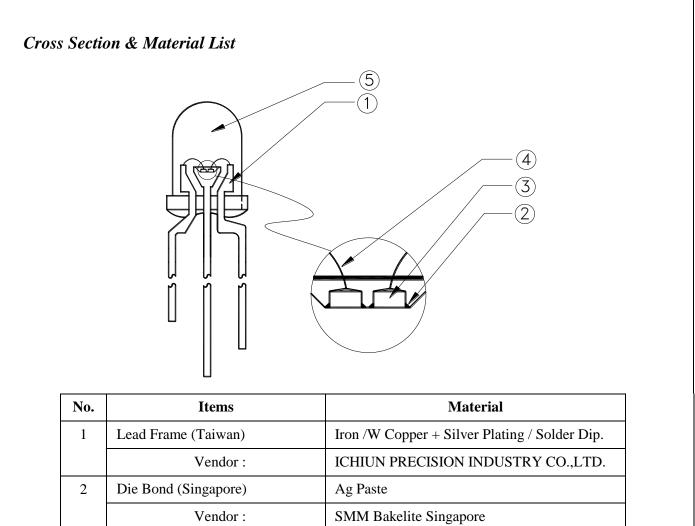
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BNS-OD-C131/A4



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vendor :	SIMM Bakente Singapore
LED Chip (Taiwan)	AllnGaP Red, GaP Green
Vendor :	EPISTAR ,OTC

	4	Bonding Wire (Singapore)	Au Wire
		Vendor :	SUMITOMO
	5	Resin (Taiwan)	Epoxy Resin / Hardener
		Vendor :	ECLAT
Ī	6	Product Weight	About 0.36g

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CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions :

Soldering iron		Wave soldering	
Temperature Soldering time	350 ~ 400 °C Max. 3.2 mm. 3.0 Sce Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED

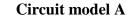
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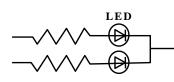
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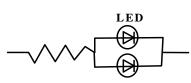
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.









(A) Recommended circuit

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs



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Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	Ta= $65\pm5^{\circ}$ C RH= 90 ~ 95% Test Time= 240HRS \pm 2HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)
Endurance Test	High Temperature High Humidity Reverse BIAS	Ta= $65\pm5^{\circ}$ C RH= 90 ~ 95% VR=5V Test Time = 500HRS (-24HRS, +48HRS)	JIS C 7021 : B-11(1982)
Storage	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)
	Temperature Cycling $105^{\circ}C \sim 25^{\circ}C \sim -55^{\circ}C \sim 25^{\circ}C$ $30mins 5mins 30mins 5mins$ 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)	
S Environmental Test S R	Thermal Shock	$\begin{array}{l} 105 \pm 5^{\circ}\mathrm{C} \sim -55^{\circ}\mathrm{C} \pm 5^{\circ}\mathrm{C} \\ 10\mathrm{mins} & 10\mathrm{mins} \\ 10\mathrm{Cycles} \end{array}$	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
	Solder Resistance	T.sol = 260 °C Max. Dwell Time= 5 secs Max. 3 Times dip	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)
	Solderability	T. sol = $230 \pm 5^{\circ}C$ Dwell Time= 5 ± 1 secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

8. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

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单击下面可查看定价,库存,交付和生命周期等信息

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